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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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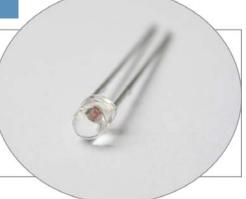


3mm (T1) Package Discrete LED TURQUOISE, Ultra Bright



3UTC-X

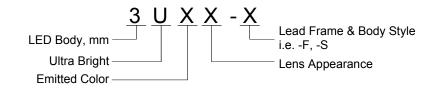
- Industry Standard 3mm (T1) Package
- RoHS Compliant
- Water Clear Lens
- Available in Flange (F) and Shouldered (S) Lead Frame styles
- Up to 800 mcd Luminous Intensity at 20 mA
- Ideal for Back Lighting, Status Indication, and Display
- Recommended for Bivar Flexible Light Pipe assemblies



Bivar 3mm T1 Package Ultra Bright LED is ideal for those applications where intensive ambient lighting exists such as Back Lighting, Signage, and Sunlight Readable applications. Bivar offers water clear LED lens for maximum light output. The Flanged LED is ideal for Panel Mount Clip & Ring assemblies. The Shouldered Lead frame LED is ideal for vertical spacer assemblies without lead bends and also has a built in strain relief feature which is ideal for right angle holder assemblies that require lead bends.

Part Number	Material	Emitted Color	Peak. Wavelength λp(nm) TYP.	Lens Appearance	Viewing Angle		
3UTC-F	GaN/SiC	TURQUOISE	500nm	Water Clear	20°		
3UTC-S	Gaiv/SIC	IUNQUUISE	5001111	Water Clear	30°		

Part Number Designation

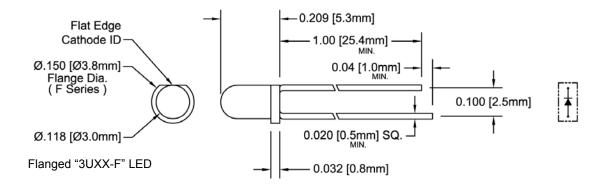




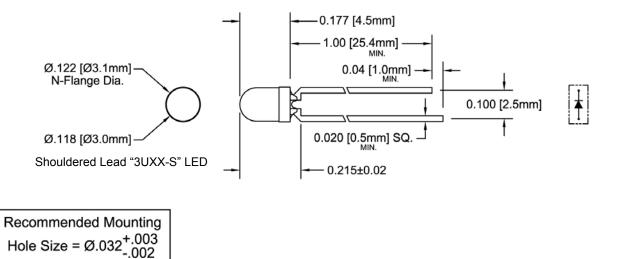


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Outline Dimensions



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Outline Drawings Notes:

1. All dimensions are in inches [millimeters].

2. Standard tolerance: ±0.010" unless otherwise noted.

3. Tolerance of overall epoxy outline: ±0.020" unless otherwise noted.

4. Epoxy meniscus may extend to 0.060" max.



Absolute Maximum Ratings

 $T_A = 25^{\circ}C$ unless otherwise noted

70 mW
30 mA
150 mA
5 V
-25 ~ +85°C
-30 ~ +100°C
260°C

Notes: 1. 10% Duty Cycle, Pulse Width \leq 0.1 msec. 2. Solder time less than 5 seconds at temperature extreme.

Electrical / Optical Characteristics

 $T_A = 25^{\circ}C \& I_F = 20 \text{ mA}$ unless otherwise noted

Part Number	Forward Voltage (V) ¹		Recommend Forward Current (mA)		Reverse Current (µA)	Dominant Wavelength (nm) ²		Luminous Intensity Iv (mcd)			Viewing Angle 2 O ½ (deg)			
	MIN	TYP	MAX	MIN	TYP	MAX	MAX	MIN	TYP	MAX	MIN	TYP	MAX	TYP
3UTC-F	/ 3.5	2 5		4.0 /	20	/	100	/	/	/	/	800	/	20
3UTC-S		3.0 2	4.0					/	/	/	/	800	/	30

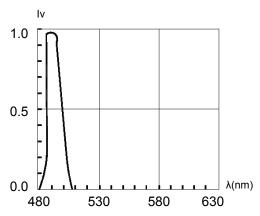
Notes: 1. Tolerance of forward voltage : ±0.05V. 2. Tolera

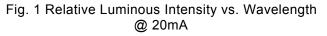
2. Tolerance of dominant wavelength : ±1.0nm.



Typical Electrical / Optical Characteristics

 $T_A = 25^{\circ}C$ unless otherwise noted





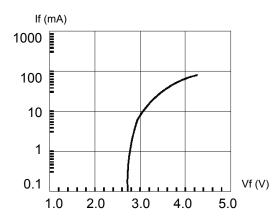


Fig. 3 Forward Current vs. Forward Voltage

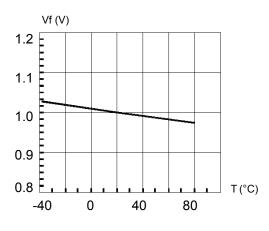


Fig. 5 Forward Voltage vs. Temperature

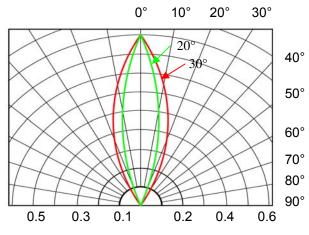


Fig. 2 Directivity Radiation Diagram

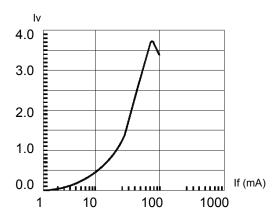


Fig. 4 Relative Luminous Intensity vs. Forward Current Normalize @ 20 mA

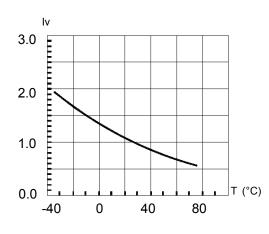
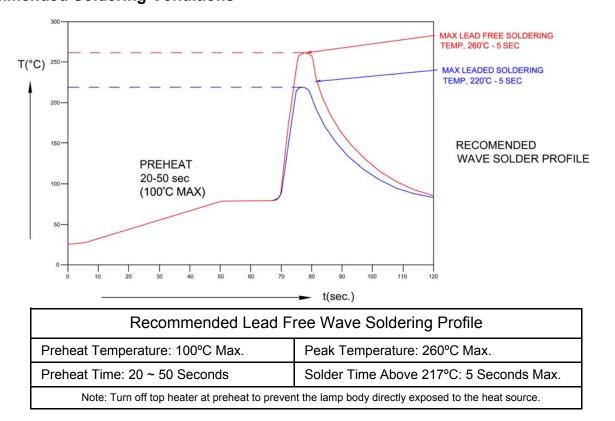


Fig. 6 Relative Luminous Intensity vs. Temperature



Recommended Soldering Conditions



Packaging and Labeling Plan

